

## **Bi-directional ESD Protection Diode**

### **FEATURES**

- Meet IEC61000-4-2 (ESD) ±15kV (air), ±8kV (contact)
- Designed for mounting on small surface
- Protects one Bi-directional I/O line
- Moisture sensitivity level 1
- Working Voltage : 5V, 12V, 24V
- Pb free version and RoHS compliant
- Packing code with suffix "G" means green compound (halogen-free)

### MECHANICAL DATA

- Case: 1005 small outline plastic package
- Terminal : Gold plated, solder per MIL-STD-705, method 2026 guaranteed
- High temperature soldering guaranteed : 260°C/10s
- Weight: 6 ± 0.5 mg

### **APPLICATIONS**

- Cell Phone Handsets and Accessories
- Notebooks, Desktops, and Servers
- Keypads, Side Keys, USB 2.0, LCD Displays

Junction and Storage Temperature Range

- Portable Instrumentation
- Touch Panel









MAXIMUM RATINGS AND ELECTRICAL CHARACTERISTICS (T <sub>A</sub> =25°C unless otherwise noted)				
PARAMETER		SYMBOL	VALUE	UNIT
Daali Dulaa Dawan	TESDL5V0	P <sub>PP</sub>	75	
Peak Pulse Power (tp=8/20µs waveform)	TESDL12V		25	W
(tp 0/20µ0 wavelolili)	TESDL24V		47	
ESD per IEC 61000-4-2 (Air)		V <sub>ESD</sub>	± 15	KV
ESD per IEC 61000-4-2 (Contact)			± 8	\ \ \ \ \ \ \ \ \ \ \ \ \ \ \ \ \ \ \

 $T_J, T_{STG}$ 

-55 to +150

PAI	RAMETER		SYMBOL	MIN	MAX	UNIT
	TESDL5V0			-	5	
Reverse Stand-Off Voltage	TESDL12V		V <sub>RWM</sub>	-	12	V
	TESDL24V			-	24	
	TESDL5V0			5.1	-	
Reverse Breakdown Voltage	TESDL12V	$I_R = 1 \text{ mA}$	V <sub>(BR)</sub>	13	-	V
	TESDL24V			25	-	
	TESDL5V0	V <sub>R</sub> = 5 V				
Reverse Leakage Current	TESDL12V	$V_R = 12 V$	I <sub>R</sub>	-	2	μΑ
	TESDL24V	$V_R = 24 V$				
Clamping Valtage	TEODI EVO	I <sub>PP</sub> = 1 A	V	-	9.8	V
Clamping Voltage	TESDL5V0	$I_{PP} = 5 A$	V <sub>c</sub>	-	15	
Clamping Voltage	TECDI 43V/	I <sub>PP</sub> = 1 A	V <sub>C</sub>	-	25	V
	TESDL12V	$I_{PP} = 5 A$		-	33	V
Clamping Voltage	TEODI 04V	I <sub>PP</sub> = 1 A	V <sub>C</sub>	-	47	\ /
	TESDL24V	$I_{PP} = 5 A$		-	51	
Junction Capacitance	TESDL5V0			15		
	TESDL12V	$V_R = 0 V$ f = 1.0 MHz	CJ	•	12	pF
	TESDL24V	1 = 1.0 IVIMZ		•	10	

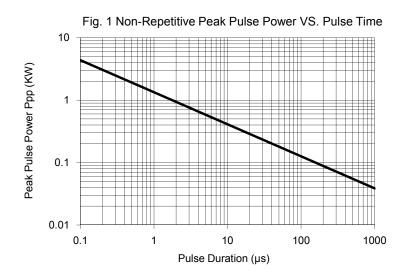
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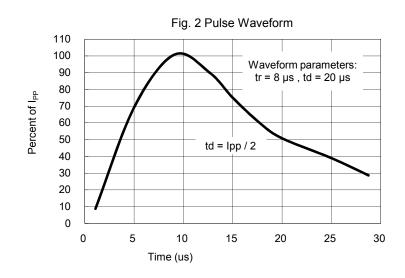
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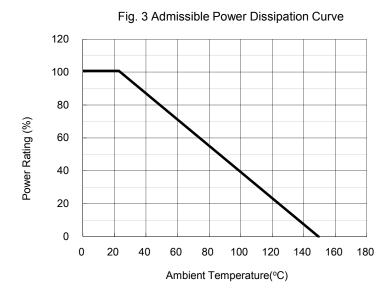


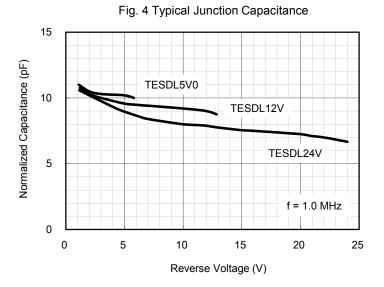
### RATINGS AND CHARACTERISTICS CURVES

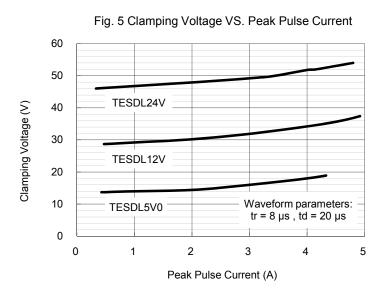
(T<sub>A</sub>=25°C unless otherwise noted)





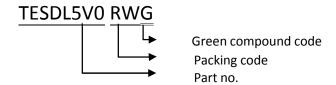




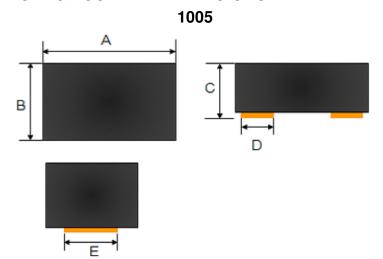




# ORDER INFORMATION (EXAMPLE)

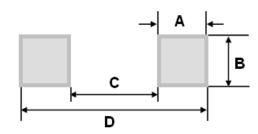


### PACKAGE OUTLINE DIMENSIONS



DIM.	Unit (mm)		Unit (inch)		
DIIVI.	Min	Max	Min	Max	
Α	2.40	2.60	0.094	0.102	
В	1.10	1.30	0.043	0.051	
С	0.70	0.90	0.028	0.035	
D	0.50 (Typ.)		0.020 (Typ.)		
Е	1.00 (Typ.)		0.040	(Тур.)	

## SUGGEST PAD LAYOUT



DIM.	Unit (mm)	Unit (inch)
DIIVI.	Тур.	Тур.
Α	0.70	0.028
В	1.30	0.051
С	1.30	0.051
D	2.70	0.106

Note: The suggested land pattern dimensions have been provided for reference only, as actual pad layouts may vary depending on application.

## MARKING

Part No.	Marking
TESDL5V0	E05
TESDL12V	E12
TESDL24V	E24

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## Taiwan Semiconductor

### APPLICATION INFROMATION

- Designed to protect one data, I/O, or power supply line
- Designed to protect sensitive electronics from damage or latch-up due to ESD
- Designed to replace multilayer varistors (MLVs) in portable applications
- Features large cross-sectional area junctions for conducting high transient currents
- Offers superior electrical characteristics such as lower clamping voltage and no device degradation when compared to MLVs
- The combination of small size and high ESD surge capability makes them ideal for use in portable applications

### CIRCUIT BOARD LAYOUT RECOMMENDATIONS

- Good circuit board layout is critical for the suppression of ESD induced transients
- Place the ESD Protection Diode near the input terminals or connectors to restrict transient coupling
- Minimize the path length between the ESD Protection Diode and the protected line
- Minimize all conductive loops including power and ground loops
- The ESD transient return path to ground should be kept as short as possible
- Never run critical signals near board edges
- Use ground planes whenever possible

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# TESDL5V0/TESDL12V/TESDL24V



**Small Signal Product** 

Taiwan Semiconductor

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